

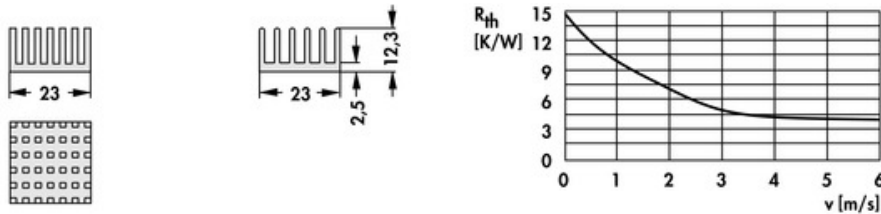
## Data sheet Product ICK PGA 8 x 8 x 12

Heatsinks and active heatsinks for processors>Heatsinks for PGA  
23 x 23 x 12.3 mm, for IC design PGA and others

### Features

way of fixation:	<ul style="list-style-type: none"> <li>• therm. conductive foil</li> <li>• therm. cond. adhesive</li> </ul>
socket:	universal
suitable for processor type:	universal
width:	23 mm
height:	12.3 mm
plate thickness:	2.5 mm
length:	23 mm
thermal resistance:	14.8 - 4 K/W
dissipation loss:	8.1 W
surface:	black anodised

### Technical Drawing



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